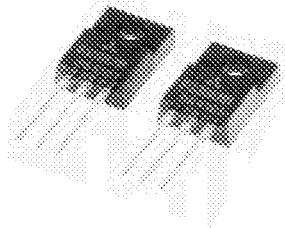


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HIGH-SPEED SWITCHING USE

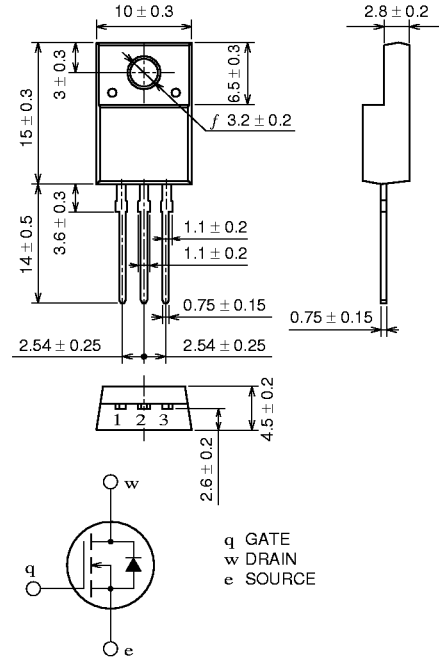
FS30KMH-06



- ˆ 2.5V DRIVE
- ˆ V_{DSS} 60V
- ˆ r_{DS} (ON) (MAX) 30mΩ
- ˆ I_D 30A
- ˆ Integrated Fast Recovery Diode (TYP.) 65ns
- ˆ V_{iso} 2000V

OUTLINE DRAWING

Dimensions in mm



TO-220FN

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (T_C = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	60	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±10	V
I _D	Drain current		30	A
I _{DM}	Drain current (Pulsed)		120	A
I _{DA}	Avalanche drain current (Pulsed)	L = 100μH	30	A
I _S	Source current		30	A
I _{SM}	Source current (Pulsed)		120	A
P _D	Maximum power dissipation		25	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
V _{iso}	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

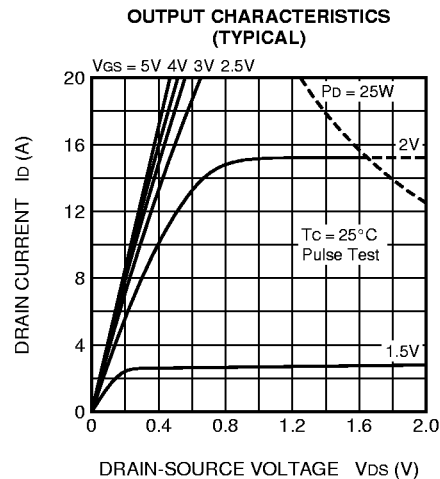
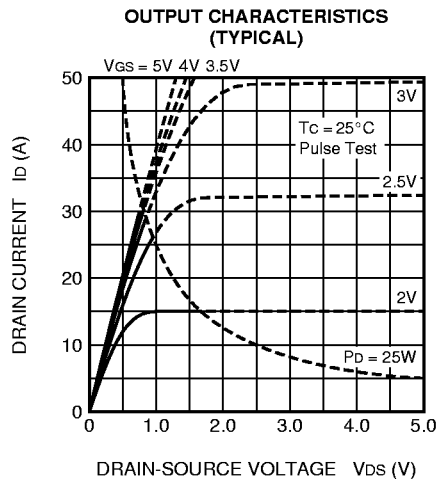
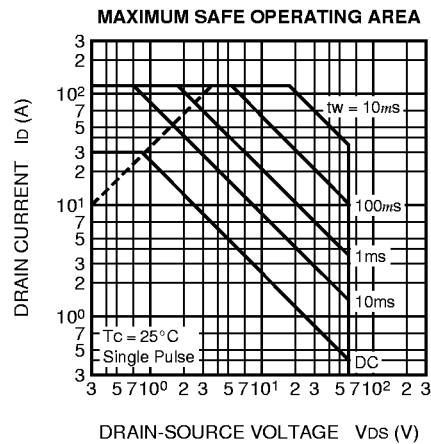
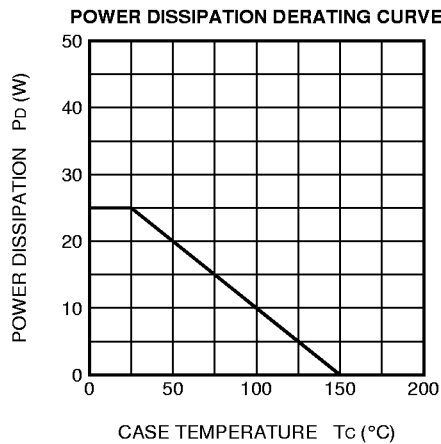
FS30KMH-06

HIGH-SPEED SWITCHING USE

ELECTRICAL CHARACTERISTICS (T_{ch} = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0V	60	—	—	V
I _{GSS}	Gate-source leakage current	V _{GS} = ±10V, V _{DS} = 0V	—	—	±0.1	μA
I _{DSS}	Drain-source leakage current	V _{DS} = 60V, V _{GS} = 0V	—	—	0.1	mA
V _{GS(th)}	Gate-source threshold voltage	I _D = 1mA, V _{DS} = 10V	0.6	0.9	1.2	V
r _{DS(ON)}	Drain-source on-state resistance	I _D = 15A, V _{GS} = 4V	—	25	30	mΩ
r _{DS(ON)}	Drain-source on-state resistance	I _D = 15A, V _{GS} = 2.5V	—	30	39	mΩ
V _{DS(ON)}	Drain-source on-state voltage	I _D = 15A, V _{GS} = 4V	—	0.38	0.45	V
y _{fs}	Forward transfer admittance	I _D = 15A, V _{DS} = 10V	—	34	—	S
C _{iss}	Input capacitance	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz	—	2000	—	pF
C _{oss}	Output capacitance		—	320	—	pF
C _{rss}	Reverse transfer capacitance		—	170	—	pF
t _{d(on)}	Turn-on delay time	V _{DD} = 30V, I _D = 15A, V _{GS} = 4V, R _{GEN} = R _{GS} = 50Ω	—	33	—	ns
t _r	Rise time		—	135	—	ns
t _{d(off)}	Turn-off delay time		—	145	—	ns
t _f	Fall time		—	150	—	ns
V _{SD}	Source-drain voltage	I _S = 15A, V _{GS} = 0V	—	1.0	1.5	V
R _{th(ch-c)}	Thermal resistance	Channel to case	—	—	5.00	°C/W
t _{rr}	Reverse recovery time	I _S = 30A, di/dt = -100A/μs	—	65	—	ns

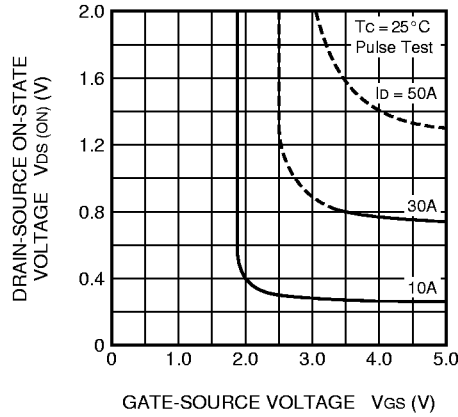
PERFORMANCE CURVES



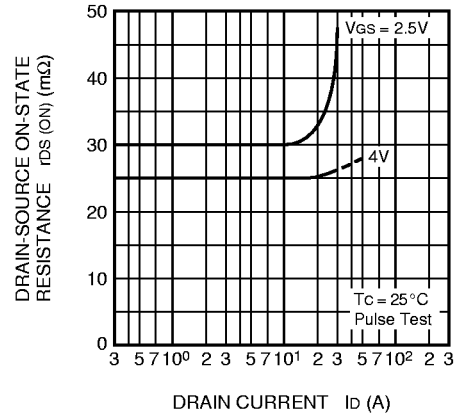
FS30KMH-06

HIGH-SPEED SWITCHING USE

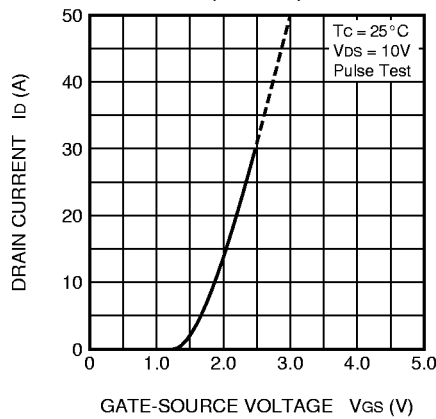
ON-STATE VOLTAGE VS.
GATE-SOURCE VOLTAGE
(TYPICAL)



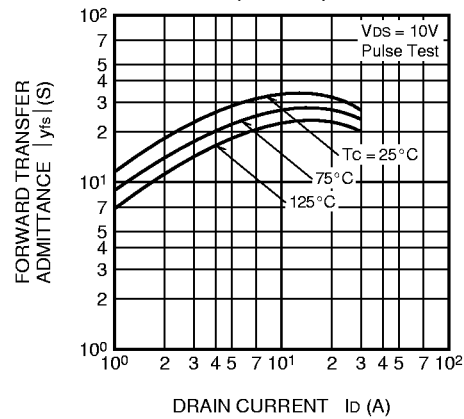
ON-STATE RESISTANCE VS.
DRAIN CURRENT
(TYPICAL)



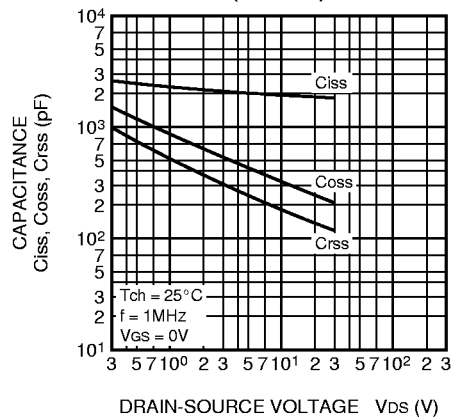
TRANSFER CHARACTERISTICS
(TYPICAL)



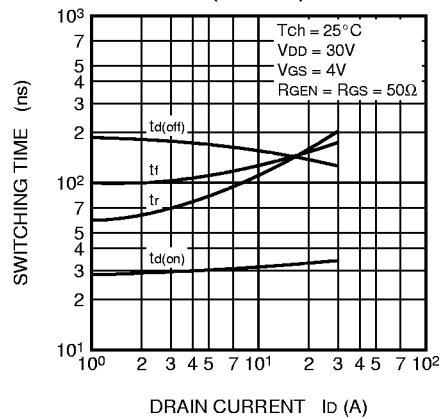
FORWARD TRANSFER ADMITTANCE
VS. DRAIN CURRENT
(TYPICAL)



CAPACITANCE VS.
DRAIN-SOURCE VOLTAGE
(TYPICAL)



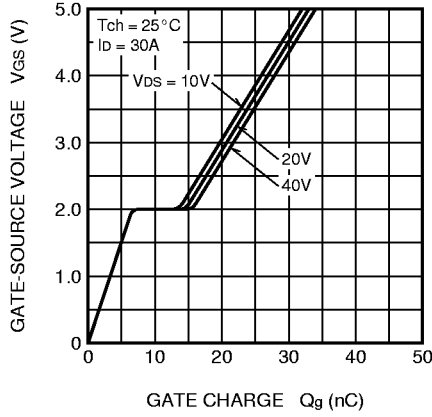
SWITCHING CHARACTERISTICS
(TYPICAL)



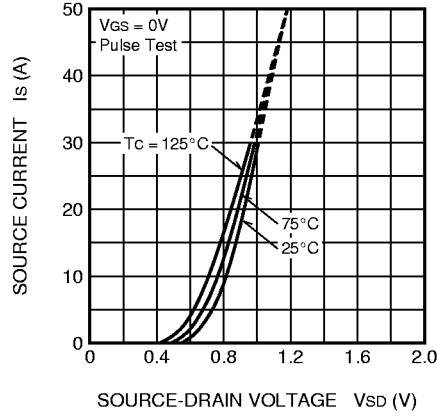
FS30KMH-06

HIGH-SPEED SWITCHING USE

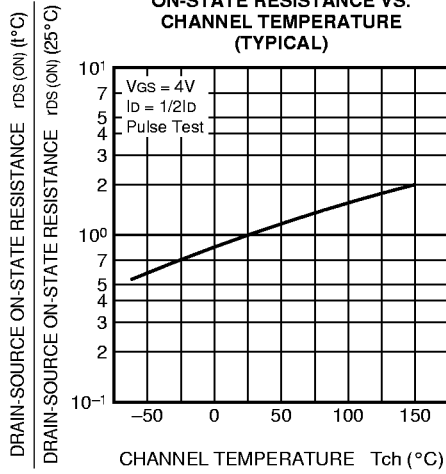
**GATE-SOURCE VOLTAGE
VS. GATE CHARGE
(TYPICAL)**



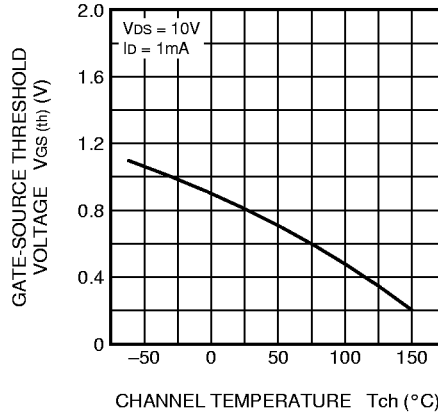
**SOURCE-DRAIN DIODE
FORWARD CHARACTERISTICS
(TYPICAL)**



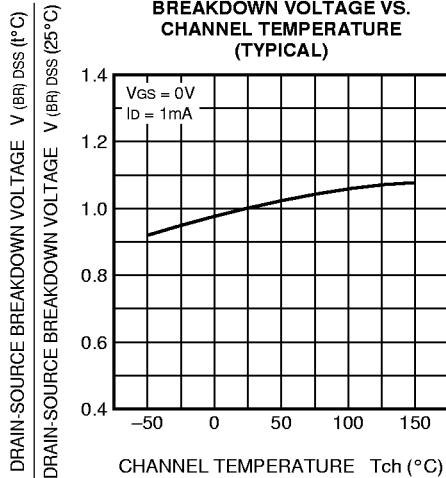
**ON-STATE RESISTANCE VS.
CHANNEL TEMPERATURE
(TYPICAL)**



**THRESHOLD VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)**



**BREAKDOWN VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)**



**TRANSIENT THERMAL IMPEDANCE
CHARACTERISTICS**

